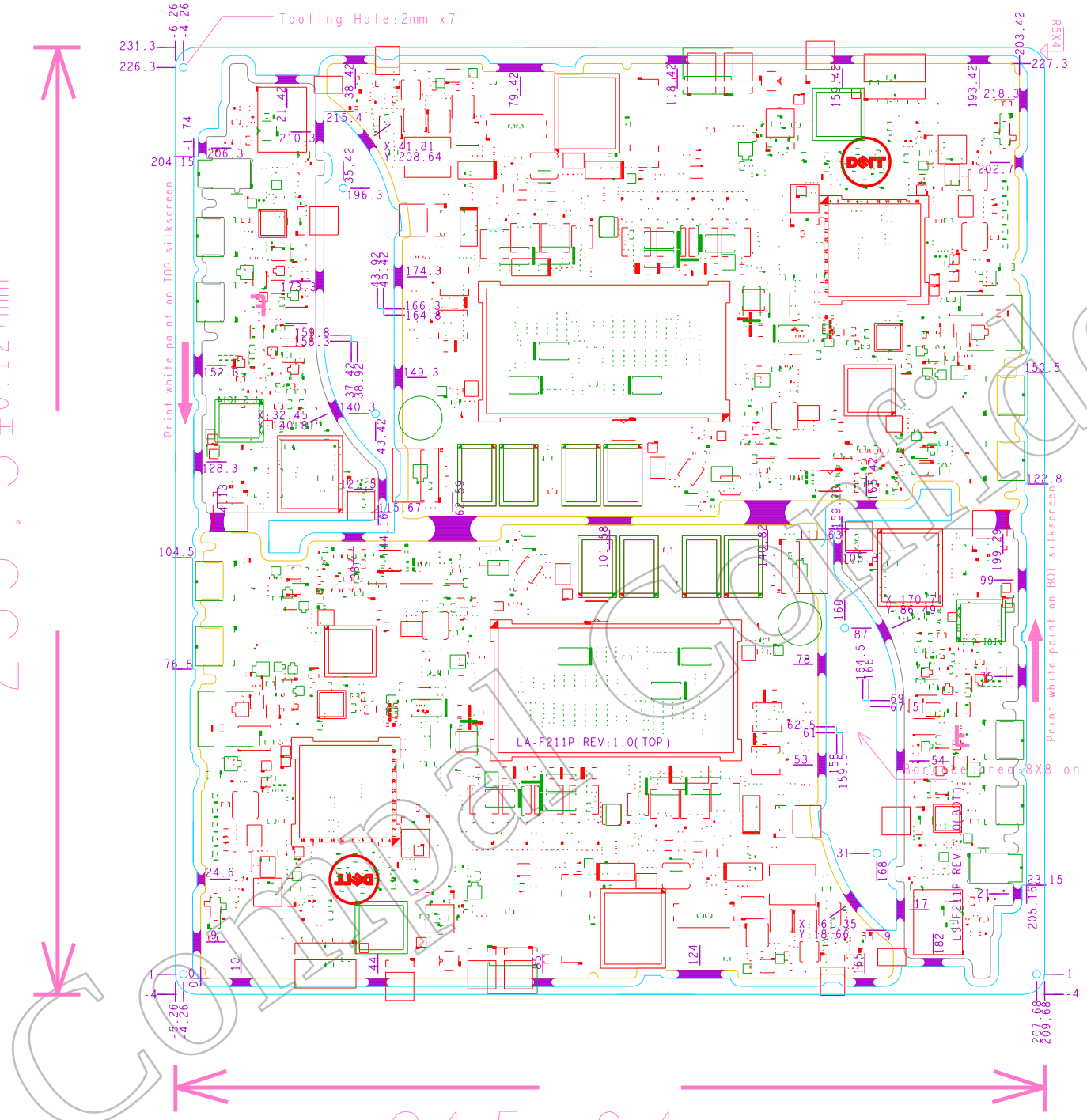

LAYER NAME	LA-F211P	LS-F211P
L1	TOP	TOP(50.85 ohm)
L2	GND1	GND1
L3	IN1	IN1(50.85 ohm)
L4	GND2	GND2
L5	IN2	IN2(50 ohm)
L6	VCC	VCC
L7	GND3	GND3
L8	IN3	IN3(50.85 ohm)
L9	GND4	GND4
L10	BOT	BOT(50 ohm)
		BOT

COMPAL ELECTRONICS. INC.	
PROJECT	DAZ10
BOARD Thickness(mm)	1.0±10%
BOARD NO.	LA-F211P REV: 1.0 LS-F211P REV: 1.0
DRAW BY	ZORA-ZHU
Issued Date	2018-01-04
Secret Level	Secret data
Decipherment date	2019-01-04

Notes:
1. To Use 2mm(min) router for breakaway
2. Refer to detail 2M,4M,8M, 10M for TAB spec.

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